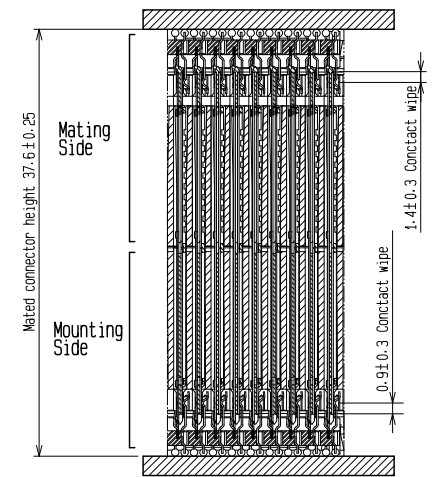
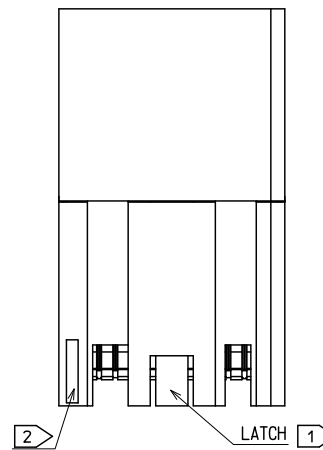


Fig. 1(FREE)



Mating Cross Section (Free)

- NOTE.
- 1 Mounting side is mated with the receptacle:IT3M-300S-BGA(**) and fixed with the latch.
 - 2 Lot No. shall be marked on the indicated position.
 - 3 The indicated mother board and daughter card shall be fastened to the additional reinforcements to prevent the stress on IT3*-300S-BGA(**) solder joints.
 4. More information of this product is available in HIROSE document :ETAD-F0347 "IT3 design guideline".
 5. This product consists of 300 signal lines and 270 ground lines.
 6. 15pcs of this products are packed in a soft tray.
 7. Standard package of 30pcs are packaged in a carton box.

3	LCP	BLACK	UL94V-0										
2	LCP	GRAY	UL94V-0	5	Copper Alloy	CONTACT AREA-NICKEL(1.5μm)+GOLD (0.76μm)							
1	PBT	BLACK	UL94V-0	4	Copper Alloy	CONTACT AREA-NICKEL(1.5μm)+GOLD (0.76μm)							
NO.	MATERIAL	FINISH	REMARKS	NO.	MATERIAL	FINISH	REMARKS						
UNITS	mm	SCALE	2 : 1	REV	COUNT	2	DESCRIPTION OF REVISIONS	DESIGNED	TK. KIKUCHI	CHECKED	TM. MATSUO	DATE	10.03.12
				DIS-F-004000						DRAWING NO.		EDC3-325232-01	
				APPROVED		M. MATSUO 09/30/2009				PART NO.		IT3-300P-38H(03)	
				CHECKED		M. MATSUO 09/30/2009				CODE NO.		CL636-0190-7-03	
				DESIGNED		T. KIKUCHI 09/30/2009							
				DRAWN		T. KIKUCHI 09/30/2009							

HRS HIROSE ELECTRIC CO., LTD.



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FORM NO. 229-1